

## ADVERTISEMENT FOR BIDS

### Building H Addition– Advanced Manufacturing Lab (RFB# Q00790)

The Harper Community College will receive sealed bids for the complete work from qualified General Contractors for the following:

PROJECT: Harper Community College  
Building H Addition Advanced Manufacturing Lab  
Palatine, Illinois

OWNER: Board of Trustees of William Rainey Harper  
District 512  
Palatine, IL

ARCHITECT: Holabird & Root LLC  
140 S. Dearborn Street  
Chicago, Illinois 60603  
(312) 357-1771  
Contact: John Howard  
Email: [jhoward@holabird.com](mailto:jhoward@holabird.com)

CONSTRUCTION  
MANAGER Power Construction Co. LLC  
8750 W. Bryn Mawr Ave., Ste. 500  
Chicago, IL 60631  
(847) 214-6351  
Contact: James Adamik  
Email: [jadamik@powerconstruction.net](mailto:jadamik@powerconstruction.net)

1. The work for this project all work as described in the drawings and specification for the construction of a new 5,500 square foot advanced Manufacturing Lab addition to Building H.
2. Work is being bid in multiple trade packages as indicated in the Documents. Separate Bid Forms must be provided for each trade package for which a bidder is submitting.
3. BIDS WILL BE DUE AT 11:00 A.M. January 15, 2015 in room A217, Building A on the Harper College Campus at 1200 West Algonquin Road, Palatine, IL 60067
4. Bids must be completed in accordance with the Project Manual, Vol. 1, Section 00 21 13 titled INSTRUCTIONS TO BIDDERS.
5. A non-mandatory PRE-BID MEETING will be held at 3:30 p.m. January 5, in room W219 of Building W at Harper Community College, Palatine, Illinois.
6. The deadline for bidders questions is January 6, 2015 at 2:00 PM. All questions during the bidding period shall be referred to John Howard, Project Architect, Holabird & Root LLC and shall be submitted in writing via email to [jhoward@holabird.com](mailto:jhoward@holabird.com) or fax to (312) 357-1909. All questions must also be submitted to Jewell Jackson, Purchasing Manager, William Rainey Harper College via email to [jjackson@harpercollege.edu](mailto:jjackson@harpercollege.edu).

Harper College

Building H Addition

Advanced Manufacturing Lab - Q00790

Issue for Bid

Holabird & Root LLC Project No. 15306.1B

12/22/2014

7. Bid Attachments: Bidders must attach documents to their bids as stated on the Bid Form and as required elsewhere in the bidding documents.
8. All Bidders must comply with the following: Contractor shall pay not less than the prevailing rates of wages to all laborers, workmen and mechanics performing work under this contract, and shall comply with the requirements of the Illinois Wages of Employees on Public Works Act (820 ILCS 130/1-12).
9. Bid security in the form of an AIA bid bond or certified check in an amount equal to ten percent (10%) of the aggregate of the Base Bid and all Alternate Bids. Certified checks will not be accepted for bid security. 100% Performance, Payment and Warranty Bonds shall be required to perform the work.
10. Harper Community College reserves the right to reject any or all Bids or waive any informalities at their discretion.
11. The Issued for Bid Drawings and Project Manual are available as prints or as electronic files in pdf format and can be obtained for the cost of reproduction from BHFX at 80 West Seegers Road, Arlington Heights, Illinois 60005, (847) 593-3161.